

L Number	Hits	Search Text	DB	Time stamp
-	750	imag\$3 and semiconduct\$3 and pixel and electronic and silicon and (detector or sensor) and read and layer and deposit\$3	USPAT; US-PGPUB	2003/04/28 06:11
-	333894	(imag\$3 and semiconduct\$3 and pixel and electronic and silicon and (detector or sensor) and read and layer and deposit\$3) and matrix or array	USPAT; US-PGPUB	2003/04/23 09:54
-	729	(imag\$3 and semiconduct\$3 and pixel and electronic and silicon and (detector or sensor) and read and layer and deposit\$3) and (matrix or array)	USPAT; US-PGPUB	2003/04/23 10:21
-	7	((imag\$3 and semiconduct\$3 and pixel and electronic and silicon and (detector or sensor) and read and layer and deposit\$3) and (matrix or array)) and vaporization	USPAT; US-PGPUB	2003/04/23 10:22
-	308	((imag\$3 and semiconduct\$3 and pixel and electronic and silicon and (detector or sensor) and read and layer and deposit\$3) and (matrix or array)) and vapor\$	USPAT; US-PGPUB	2003/04/23 10:22
-	308	((imag\$3 and semiconduct\$3 and pixel and electronic and silicon and (detector or sensor) and read and layer and deposit\$3) and (matrix or array)) and vapor\$7	USPAT; US-PGPUB	2003/04/23 16:54
-	6	close adj space adj vapor adj transport	USPAT; US-PGPUB	2003/04/23 17:37
-	0	(close adj space adj vapor adj transport) and imag\$3	USPAT; US-PGPUB	2003/04/23 17:38
-	77	250/370.12.ccls.	USPAT; US-PGPUB	2003/04/23 17:39
-	378	250/338.4.ccls.	USPAT; US-PGPUB	2003/04/23 17:39
-	1172	250/338.1.ccls.	USPAT; US-PGPUB	2003/04/23 17:40
-	515	250/336.1.ccls.	USPAT; US-PGPUB	2003/04/23 17:40
-	483	250/370.01.ccls.	USPAT; US-PGPUB	2003/04/23 17:41
-	135	250/370.13.ccls.	USPAT; US-PGPUB	2003/04/23 17:41
-	2415	250/370.12.ccls. or 250/338.4.ccls. or 250/338.1.ccls. or 250/336.1.ccls. or 250/370.01.ccls. or 250/370.13.ccls.	USPAT; US-PGPUB	2003/04/23 17:42
-	842	(250/370.12.ccls. or 250/338.4.ccls. or 250/338.1.ccls. or 250/336.1.ccls. or 250/370.01.ccls. or 250/370.13.ccls.) and imag\$3	USPAT; US-PGPUB	2003/04/23 17:42
-	337	((250/370.12.ccls. or 250/338.4.ccls. or 250/338.1.ccls. or 250/336.1.ccls. or 250/370.01.ccls. or 250/370.13.ccls.) and imag\$3) and pixel	USPAT; US-PGPUB	2003/04/23 17:44
-	236	((250/370.12.ccls. or 250/338.4.ccls. or 250/338.1.ccls. or 250/336.1.ccls. or 250/370.01.ccls. or 250/370.13.ccls.) and imag\$3) and pixel) and semiconduct\$3	USPAT; US-PGPUB	2003/04/24 11:42
-	1	(6548263.PN. and ((imag\$3 and semiconduct\$3 and pixel and electronic and silicon and (detector or sensor) and read and layer and deposit\$3) and (matrix or array)) and vapor\$7)) and (array or matrix)	USPAT; US-PGPUB	2003/04/23 17:45
-	0	(matrix or array) and semiconduct\$3 and pixel and silicon and (reading adj panel) and electronic and (vapor adj deposition)	USPAT; US-PGPUB	2003/04/24 11:44
-	3029	(matrix or array) and semiconduct\$3 and pixel and (vapor adj deposition)	USPAT; US-PGPUB	2003/04/24 11:45
-	0	(matrix or array) and semiconduct\$3 and pixel and (reading adj panel) and electronic and (vapor adj deposition)	USPAT; US-PGPUB	2003/04/24 11:45

-	0	(matrix or array) and semiconductor\$3 and pixel and (reading adj panel) and (vapor adj deposition)	USPAT; US-PGPUB	2003/04/24 11:45
-	2875	((matrix or array) and semiconductor\$3 and pixel and (vapor adj deposition)) and (silicon or SI)	USPAT; US-PGPUB	2003/04/24 11:46
-	2225	((matrix or array) and semiconductor\$3 and pixel and (vapor adj deposition)) and (silicon or SI)) and imag\$3	USPAT; US-PGPUB	2003/04/24 11:46
-	848	((matrix or array) and semiconductor\$3 and pixel and (vapor adj deposition)) and (silicon or SI)) and imag\$3) and (detector or sensor)	USPAT; US-PGPUB	2003/04/24 11:47
-	575	((matrix or array) and semiconductor\$3 and pixel and (vapor adj deposition)) and (silicon or SI)) and imag\$3) and (detector or sensor)) and integrated	USPAT; US-PGPUB	2003/04/24 11:54
-	81979	(vapor adj deposition)	USPAT; US-PGPUB	2003/04/24 11:54
-	9324	(vapor adj deposition) with semiconductor	USPAT; US-PGPUB	2003/04/24 11:55
-	187	(vapor adj deposition) near semiconductor	USPAT; US-PGPUB	2003/04/24 11:55
-	10	((vapor adj deposition) near semiconductor) and imag\$3	USPAT; US-PGPUB	2003/04/24 12:01
-	1400	((vapor adj deposition) with semiconductor) and imag\$3	USPAT; US-PGPUB	2003/04/24 12:03
-	335	((vapor adj deposition) with semiconductor) and imaging	USPAT; US-PGPUB	2003/04/24 12:03
-	9825	(vapor adj deposition) with semiconductor\$3	USPAT; US-PGPUB	2003/04/28 06:12
-	476	((vapor adj deposition) with semiconductor\$3 ) and pixel	USPAT; US-PGPUB	2003/04/28 06:12
-	4	((vapor adj deposition) with semiconductor\$3 ) and pixel) and scintillat\$3	USPAT; US-PGPUB	2003/04/28 06:12

1